

Form Type	Distribute	Version	2.0		Ref		IPC 175	2A	Sectional	s Material In	fo S	ubsectionals	D, A	
			1		-	Supplier li				1			1-,	
Company Name	TE Connectivi					Contact			r, David W	Contact Title	Staff	Mfg & Process	Dvl Engineer	
Company	TE Connectivit	Document I ty Response I		2018-04-04		Contact	Email	dave.b	penfer@te.c	om				
Unique ID	1	-	.4 747 000 0707			<u> </u>								
Contact Phone	Number	+1-717-986-	-3725			1 1 0								
Supplier	true					Legai Si	atement							
Acceptance														
Legal Statemen						. ,		T 1 · · · ·						
										subject to chang nectivity (or its aff				
						Pro	duct					•		
Manufacturer Item number	1-1337581-0	Amount	!	925.0		Version		-		Identity				
Manufacturer Item Name	MCX Str PCB Skt 50Ohm Go Pltd	Weight Uor	n	mg		Mfr Site				Authority				
Date		иом		Each										
EURoHS-0508	Product(s) me	ets EU RoHS red	quireme	ents by ap	plicatio	n of the se	elected ex	emption	n(s)					
ChinaRoHS- 0508	Product(s) is N	Product(s) meets EU RoHS requirements by application of the selected exemption(s) Product(s) is NOT eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products												
EUREACH-0117	REACH Candi	date Substances	of Ver	ry High Co	ncern A	ARE NOT	Yet Revi	ewed						
Complex Article Description	REACH Candi	date Substances	of Ver	ry High Co	ncern a	according	to Once a	n Article	e Always ar	Article are Not	et Revie	ewed		
						Product D	Disclosu	е						
Sub- Item/Material/ Substance	al/ Level Name		Substance Category		Substance CAS		Substance Concentration		Quantity	Mass per	Unit U	ОМ	Exemption	
Material	1	BODY							1.0	856.0	m	ng		
Substance	2	Lead		I/Lead 7439-9		92-1	3.15		1.0	26.964	m	ng	6(c) Lead as an alloying element in copper containing up to 4% lead by weight	
Substance	2	Zinc	Suppl	olier 7440-6		66-6 38.46		1.0		329.2176	m	ng		
Substance	2	Copper	er Suppli		olier 7440-5		50-8 58.11		1.0	497.4216	m	ng		
Substance	2	Iron	Supplier		ier 7439-8		39-6 0.28		1.0	2.3968	m	ng		
atoriai	1	INSULATOR	 -				+		1.0	12.0	m	ng		
Substance	Ethene, 1,1,2,2- tetrafluoro-, homopolymer		Suppl	Supplier 900		02-84-0 10		1.0		12.0	m	ng		
Material	1	NICKEL PLATING							1.0	7.0	m	ng		
Substance	2	Nickel	Nickel		7440-02-0		100.0		1.0	7.0	m	ng		
	1	CONTACT PIN							1.0	48.0	m			
Substance	2 Lead		Compounds		7439-	0.35		1.0		0.168	m	ng	6(c) Lead as an alloying element in copper containing up to 4% lead by weight	
	2	Iron	Supplier		7439-89-6		0.9		1.0	0.432	m	ng		
	2	Beryllium			7440-41-7		1.8		1.0	0.864	m	ng		
	Copper		Supplier		7440-	50-8			1.0	46.536	m	-		
Material	1	GOLD PLATING							1.0	2.0	m	ng		
Substance	2	Gold	Suppl	ier	7440-	57-5	100.0		1.0	2.0	m	ng		